PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	577	STMicroelectronics International N.V
1.2 PCN No.		AMS/18/11220
1.3 Title of PCN		Introduction of a Super High Density Lead-frame in ST Bouskoura for Automotive Grade products assembled in SO8 package
1.4 Product Category		See product list
1.5 Issue date		2018-12-06

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	ROBERTSON HEATHER	
2.1.2 Phone	+1 8475853058	
2.1.3 Email	heather.robertson@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Lorenzo NASO	
2.1.2 Marketing Manager	Marcello SAN BIAGIO	
2.1.3 Quality Manager	Jean-Marc BUGNARD	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
Materials	New direct material part number r (same supplier, different supplier or new supplier),(Lead frame dimensions)	Assembly = ST Bouskoura (Morocco)	

4. Description of change			
	Old	New	
	Standard / High density Lead-frame (depending on the product)	Super High density Lead-frame	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact		

5. Reason / motivation for change		
5.1 Motivation	The release of this Super High density Lead-frame will help us to better support our customer's demand and provide a better delivery service. This new Lead-frame format will NOT affect the internal structure of the lead-frame, it will only allow us to treat more pieces in production at a time so it can be considered as a MINOR change.	
5.2 Customer Benefit	SERVICE IMPROVEMENT	

6. Marking of parts / traceability of change		
6.1 Description	New Finished good codes	

7. Timing / schedule		
7.1 Date of qualification results	2018-11-15	
7.2 Intended start of delivery	2019-06-25	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
3.1 Description 11220 Qual report SOSSHD Bouskoura_Nov2018-general case.pdf			
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2018-12-06

9. Attachments (additional documentations)

11220 Public product.pdf 11220 Qual report SOSSHD Bouskoura_Nov2018-general case.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No	
	LM258AYDT		
	LM258WYDT		
	LM2903HYDT		
	LM2903WYDT		
	LM2903YDT		
	LM2904AYDT		
	LM2904YDT		
	LM358YDT		
	LMV358IYDT		
	LMV822AIYDT		
	LMV822IYDT		
	MC33078YDT		
	TL072BIYDT		
	TL082AIYDT		
	TL082BIYDT		
	TL082IYDT		
	TS1872IYDT		
	TS332IYDT		
	TS512BIYDT		
	TS9222IYDT		
	TS922AIYDT		
	TS922IYDT		
	TSC102IYDT		
	TSC1031IYDT		
	TSC103IYDT		
	TSV358AIYDT		
	TSV358IYDT		
	TSV632IYDT		
	TSV852AIYDT		
	TSV852IYDT		
	TSV911AIYDT		
	TSV912HYDT		
	TSV912IYDT		
	TSV992AIYDT		
	TSV992IYDT		

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Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title: Introduction of a Super High Density Lead-frame in ST Bouskoura for Automotive Grade products assembled in SO8

package

PCN Reference: AMS/18/11220

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

TS912IYDT	TSC103IYDT	TS912AIYDT
TS512AIYDT	LMV358IYDT	TS972IYDT
LM2904WHYDT	TS1872IYDT	TS512IYDT
TS922IYDT	TL082BIYDT	TL082IYDT
LM2904WYDT	LMV822AIYDT	TSV911IYDT
MC33078YDT	TSV632IYDT	TSV992AIYDT
TS393IYDT	TS1872AIYDT	TSV912HYDT
TSV992IYDT	LM2903WYDT	TS912BIYDT
LM258WYDT	TSV852IYDT	LM2904AYDT
TS952IYDT	LM2903HYDT	TS9222IYDT
TSC102IYDT	LM2904YDT	LMV822IYDT
LM2903YDT	TL072BIYDT	TS922AIYDT
TSV912IYDT	TS512BIYDT	TSV852AIYDT
TSV991AIYDT	TSV912AIYDT	TSV358IYDT
TSV358AIYDT	TSV911AIYDT	TSC1031IYDT
TSV991IYDT	TL082AIYDT	TS332IYDT

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